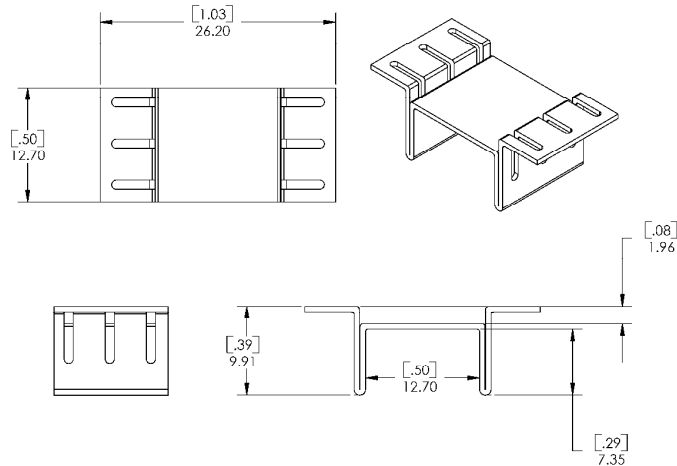
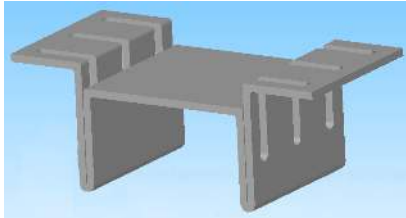


# Board Level Heat Sinks



ThermaFlo

P/N: 832700T00000 & 8327TRT00000



## PRODUCT SPECIFICATIONS

- Devices: D2 PAK, TO-263
- Size: 26.2 x 12.7 x 9.9 mm
- Copper, 0.6 mm Thick
- Type: Stamped
- PCB Mounting: Surface Mount Technology
- Finish: Tin Plate
- Package: Bulk or Tape & Reel

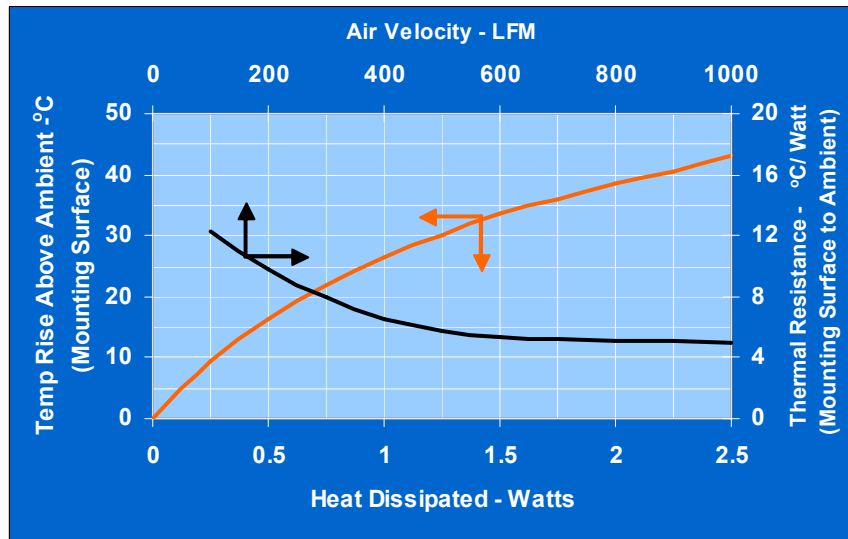
## FEATURES & BENEFITS

- No Hardware Device Attachment
- Direct SMT Contact to PCB
- Solderable Legs
- RoHS Compliant



## CUSTOMIZED HEATSINKS

- Specialized Body Configurations
- Contact Applications Engineering



D2 PAK, TO-263

| Part Number  | Packaging   | Notes                                   |
|--------------|-------------|---|
| 832700T00000 | Bulk        |   |
| 8327TRT00000 | Tape & Reel | Contact Factory for Tape and Reel Specs |

## COMAIR ROTRON, INC

8929 Terman Court, San Diego, CA 92121

Ph (858) 348-6200 Fax (858) 566-4577

E-mail: sales@comairrotron.com,

Web: www.comairrotron.com